

**Absolute Maximum Ratings**(Note 1)

Supply Voltage ( $V_{CC}$ )	-0.5V to +7.0V
DC Input Voltage ( $V_{IN}$ )	-0.5V to +7.0V
DC Output Voltage ( $V_{OUT}$ )	-0.5V to +7.0V
DC Input Diode Current ( $I_{IK}$ )	
$V_{IN} < 0V$	-50 mA
DC Output Diode Current ( $I_{OK}$ )	
$V_{OUT} < 0V$	-50 mA
DC Output Source/Sink Current ( $I_{OUT}$ )	$\pm 50$ mA
DC $V_{CC}/GND$ Current ( $I_{CC}/I_{GND}$ )	$\pm 100$ mA
Storage Temperature ( $T_{STG}$ )	-65°C to +150°C
Junction Temperature under Bias ( $T_J$ )	150°C
Junction Lead Temperature ( $T_L$ ) (Soldering, 10 seconds)	260°C
Power Dissipation ( $P_D$ ) @ +85°C	180 mW

**Recommended Operating Conditions** (Note 2)

Supply Voltage	Operating ( $V_{CC}$ )	1.65V to 5.5V
Data Retention		1.5V to 5.5V
Input Voltage ( $V_{IN}$ )		0V to 5.5V
Output Voltage ( $V_{OUT}$ )		0V to $V_{CC}$
Input Rise and Fall time ( $t_r, t_f$ )		
$V_{CC} = 1.8V, 2.5V \pm 0.2V$		0 to 20 ns/V
$V_{CC} = 3.3V \pm 0.3V$		0 to 10 ns/V
$V_{CC} = 5.5V \pm 0.5V$		0 to 5 ns/V
Operating Temperature ( $T_A$ )		-40°C to +85°C
Thermal Resistance ( $\theta_{JA}$ )		350°C/W

**Note 1:** Absolute maximum ratings are DC values beyond which the device may be damaged or have its useful life impaired. The datasheet specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation outside datasheet specifications.

**Note 2:** Unused inputs must be held HIGH or LOW. They may not float.

**DC Electrical Characteristics**

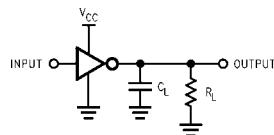
Symbol	Parameter	$V_{CC}$ (V)	$T_A = +25^\circ C$			Units	Conditions
			Min	Typ	Max		
$V_{IH}$	HIGH Level Control Input Voltage	1.65 to 1.95 2.3 to 5.5	0.75 $V_{CC}$ 0.7 $V_{CC}$		0.75 $V_{CC}$ 0.7 $V_{CC}$	V	
	LOW Level Control Input Voltage	1.65 to 1.95 2.3 to 5.5		0.25 $V_{CC}$ 0.3 $V_{CC}$			
$V_{OH}$	HIGH Level Control Output Voltage	1.65 1.8 2.3 3.0 4.5	1.55 1.7 2.2 2.9 4.4	1.65 1.8 2.3 3.0 4.5	1.55 1.7 2.2 2.9 4.4	V	$I_{OH} = -100 \mu A$  $I_{OH} = -4 mA$ $I_{OH} = -8 mA$ $I_{OH} = -16 mA$ $I_{OH} = -24 mA$ $I_{OH} = -32 mA$
		1.65 2.3 3.0 3.0 4.5	1.29 1.9 2.4 2.3 3.8	1.52 2.14 2.75 2.62 4.13	1.29 1.9 2.4 2.3 3.8		
		1.65 1.8 2.3 3.0 4.5	0.1 0.0 0.0 0.0 0.0	0.1 0.1 0.1 0.1 0.1	0.1		
		1.65 2.3 3.0 3.0 4.5		0.08 0.10 0.16 0.24 0.25	0.24		
		1.65 2.3 3.0 3.0 4.5		0.24 0.3 0.4 0.55 0.55	0.3 0.4 0.55 0.55		
		1.65 1.8 2.3 3.0 4.5		0.55 0.55 0.55 0.55 0.55	0.55		
		1.65 1.8 2.3 3.0 4.5		0.24 0.3 0.4 0.55 0.55	0.24		
		1.65 1.8 2.3 3.0 4.5		0.08 0.10 0.16 0.24 0.25	0.08 0.10 0.16 0.24 0.25		
		1.65 1.8 2.3 3.0 4.5		0.24 0.3 0.4 0.55 0.55	0.24 0.3 0.4 0.55 0.55		
		1.65 1.8 2.3 3.0 4.5		0.55 0.55 0.55 0.55 0.55	0.55		
$I_{IN}$	Input Leakage Current	0 to 5.5		$\pm 0.1$	$\pm 1.0$	$\mu A$	$0 \leq V_{IN} \leq 5.5V$
$I_{OFF}$	Power Off Leakage Current	0.0		1.0	10	$\mu A$	$V_{IN}$ or $V_{OUT} = 5.5V$
$I_{CC}$	Quiescent Supply Current	1.65 to 5.5		1.0	10	$\mu A$	$V_{IN} = 5.5V, GND$

## AC Electrical Characteristics

Symbol	Parameter	V <sub>CC</sub> (V)	T <sub>A</sub> = +25°C			T <sub>A</sub> = -40°C to +85°C		Units	Conditions	Fig. No.
			Min	Typ	Max	Min	Max			
t <sub>PLH</sub>	Propagation Delay	1.65	1.8	5.3	9.2	1.8	11.0	ns	C <sub>L</sub> = 15 pF, R <sub>L</sub> = 1 MΩ	Figures 1, 3
		1.8	1.8	4.4	7.6	1.8	8.4			
		2.5 ± 0.2	1.2	3.0	5.1	1.2	5.6			
		3.3 ± 0.3	0.8	2.2	3.4	0.8	3.8			
		5.0 ± 0.5	0.5	1.8	2.8	0.5	3.1			
t <sub>PLH</sub>	Propagation Delay	3.3 ± 0.3	1.2	2.9	4.5	1.2	5.0	ns	C <sub>L</sub> = 50 pF, R <sub>L</sub> = 500Ω	Figures 1, 3
		5.0 ± 0.5	0.8	2.3	3.6	0.8	4.0			
C <sub>IN</sub>	Input Capacitance	0		2.5				pF		
C <sub>PD</sub>	Power Dissipation	3.3		9				pF	(Note 3)	Figure 2
	Capacitance	5.0		11						

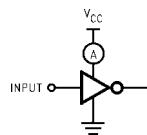
Note 3: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I<sub>CCD</sub>) at no output loading and operating at 50% duty cycle. (See Figure 2.) C<sub>PD</sub> is related to I<sub>CCD</sub> dynamic operating current by the expression:  
 $I_{CCD} = (C_{PD})(V_{CC})(f_{IN}) + (I_{CCstatic})$

## AC Loading and Waveforms



C<sub>L</sub> includes load and stray capacitance  
Input PRR = 1.0 MHz; t<sub>W</sub> = 500 ns

FIGURE 1. AC Test Circuit



Input = AC Waveform; t<sub>r</sub> = t<sub>f</sub> = 1.8 ns;  
PRR = variable; Duty Cycle = 50%

FIGURE 2. I<sub>CCD</sub> Test Circuit

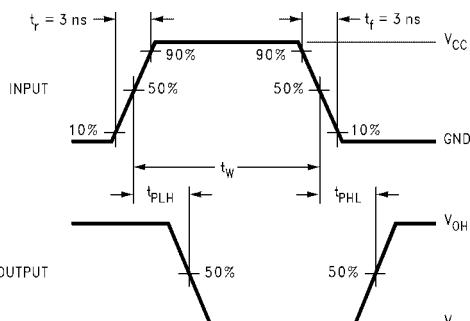


FIGURE 3. AC Waveforms

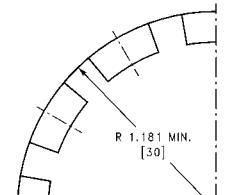
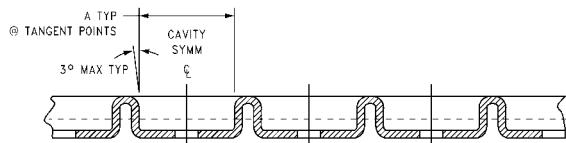
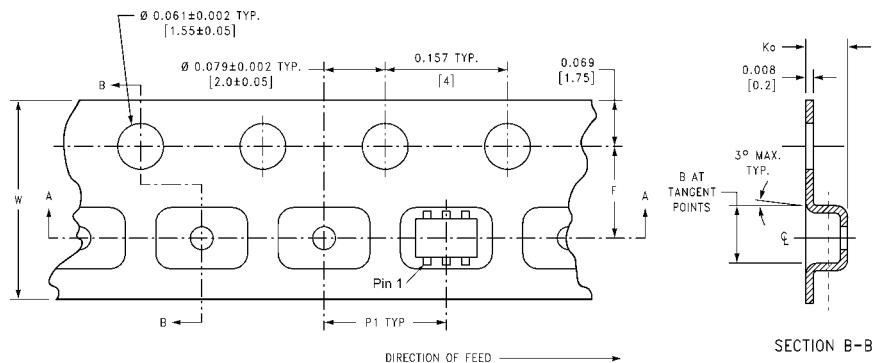
NC7WZ04

## Tape and Reel Specification

### TAPE FORMAT

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
P6	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	250	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed
P6X	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

### TAPE DIMENSIONS inches (millimeters)

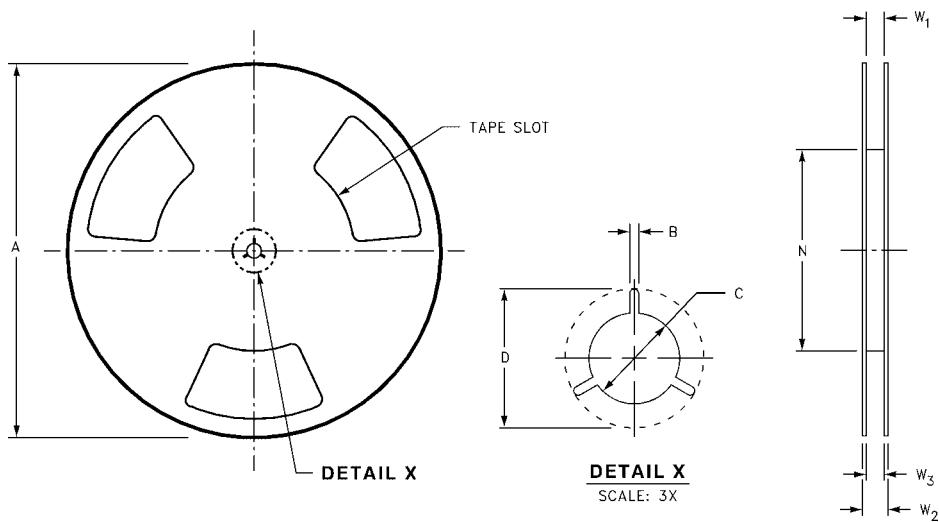


Package	Tape Size	DIM A	DIM B	DIM F	DIM Ko	DIM P1	DIM W
SC70-6	8 mm	0.093 (2.35)	0.096 (2.45)	0.138 ± 0.004 (3.5 ± 0.10)	0.053 ± 0.004 (1.35 ± 0.10)	0.157 (4)	0.315 ± 0.004 (8 ± 0.1)

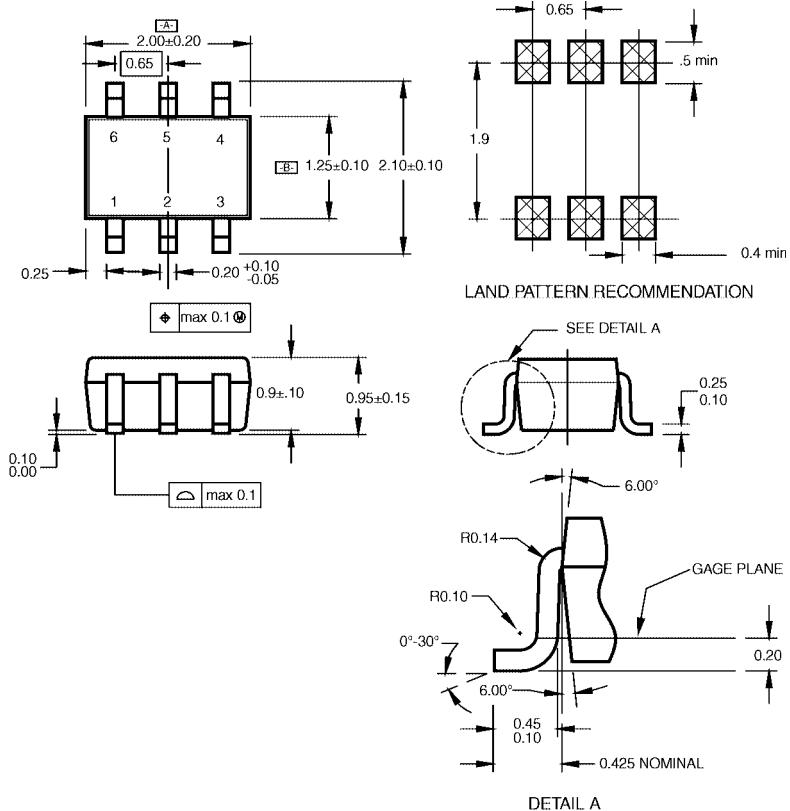
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## Tape and Reel Specification (Continued)

### REEL DIMENSIONS inches (millimeters)



Tape Size	A	B	C	D	N	W1	W2	W3
8 mm	7.0 (177.8)	0.059 (1.50)	0.512 (13.00)	0.795 (20.20)	2.165 (55.00)	0.331 + 0.059/-0.000 (8.40 + 1.50/-0.00)	0.567 (14.40)	W1 + 0.078/-0.039 (W1 + 2.00/-1.00)

**Physical Dimensions** inches (millimeters) unless otherwise noted

## NOTES:

A. CONFORMS TO EIAJ REGISTERED OUTLINE DRAWING SC88.

MAA06ARevC

B. DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH.

C. DIMENSIONS ARE IN MILLIMETERS.

**6-Lead SC70, EIAJ SC88, 1.25mm Wide  
Package Number MAA06A**

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